

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Wen-Huang Liu	04/13/2010
Li-Wei Shan	04/13/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SemiLEDs Optoelectronics Co., Ltd.
<b>Street Address:</b>	3F, No. 11, Ke Jung Chu-Nan
<b>City:</b>	Miao-Li County
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	350
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29346240
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(208)389-7515
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	+886-37586788
<b>Email:</b>	chin1425@hotmail.com
<b>Correspondent Name:</b>	SemiLEDs Optoelectronics Co., Ltd.
<b>Address Line 1:</b>	3F, No. 11, Ke Jung Rd.,Chu-Nan
<b>Address Line 4:</b>	Miao-Li County, TAIWAN 350
<b>NAME OF SUBMITTER:</b>	Lan-Fang Chin
<b>Total Attachments: 2</b> source=SEMI_2009-009USassign#page1.tif source=SEMI_2009-009USassign#page2.tif	

OP \$40.00 29346240

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

LI-WEI SHAN  
WEN-HUANG LIU

Serial No.:

Filing Date: 2009/10/29

Title: SUBSTRATE FOR A SURFACE MOUNT  
LIGHT EMITTING DIODE

Docket No. SEMI/2009-009US

ASSIGNMENT:

Enclosed for recording  
 Previously recorded

Date: \_\_\_\_\_

Reel: \_\_\_\_\_

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency, and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN, AND TRANSFER to SemiLEDs Optoelectronics Co., Ltd., a Taiwanese company with its business address at 3F, No. 11, Ke Jung Rd., Chu-Nan Site, Hsinchu Science Park, Chu-nan 350, Miao-Li County, Taiwan, R.O.C. (the "Assignee), the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which will be executed by the undersigned and is entitled: **SUBSTRATE FOR A SURFACE MOUNT LIGHT EMITTING DIODE** ; such application and all divisional, continuing, substitute, renewal, reissue, and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST, the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney, and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining, and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives, and successors of the undersigned and extend to the successors, assigns, and nominees of the Assignee.

(Signature) Li-Wei Shan Date 10/29/2009  
LI-WEI SHAN

(Signature) Wen-Huang Liu Date 10/29/2009  
~~WEN-HUANG LIU~~  
WEN